### **Not Recommended for New Designs**



28 Volt M-Grade PI31xx-00-HVMZ



# 28V<sub>IN</sub>, 3.3 to 15V<sub>OUT</sub>, ZVS Isolated Converter Module Family

#### **Product Description**

The ZVS Isolated Converter Module Series consists of high-density isolated DC-DC converters implementing Zero-Voltage Switching topology.

The  $28V_{IN}$  series operates over a wide range input of 16V to  $50V_{DC}$ , delivering 50W of output power, yielding an unprecedented power density of  $334W/in^3$ .

These converter modules are surface mountable and only ~0.5in square in area achieving ~50% space reduction versus conventional solutions.

Device	Ou	I May	
	Set	Range	I <sub>OUT</sub> Max
PI3108-00-HVMZ	3.3V	2.97 – 3.63V	10A
PI3109-00-HVMZ	5V	4 – 5.5V	10A
PI3106-00-HVMZ	12V	9.6 – 13.2V	4.2A
PI3111-00-HVMZ	15V	12 – 16.5V	3.33A

The switching frequency of 900kHz allows for small input and output filter components which further reduces the total size and cost of the overall system solution. The output voltage is sensed and fed back to the internal controller using a high performance isolated magnetic feedback scheme which allows for high bandwidth and good common mode noise immunity.

The PI31xx-00-HVMZ series requires no external feedback compensation and offers a total solution with a minimum number of external components. A rich feature set is offered, including output voltage trim capability, output overvoltage protection, adjustable soft start, overcurrent protection with auto-restart, over and under input voltage lockout and a temperature monitoring and protection function that provides an analog voltage proportional to the die temperature as well as shut down and alarm capabilities.

#### **Features & Benefits**

- Efficiency up to 88%
- High switching frequency minimizes input filter requirements and reduces output capacitance
- Proprietary "Double-Clamped" ZVS Buck-Boost Topology
- · Proprietary isolated magnetic feedback
- Small footprint (0.57in<sup>2</sup>) enables PCB area savings
- Very low profile (0.265in)
- Wide input voltage range operation (16 50V<sub>DC</sub>)
- On/Off Control, positive logic
- Wide trim range +10/-20% most models
- Temperature Monitor (TM) & Overtemperature Protection (OTP)
- Input UVLO & OVLO and output OVP
- Overcurrent protection with auto restart
- Adjustable soft start
- 2250V<sub>DC</sub> input-to-output isolation

#### **Applications**

- Wide Temperature, Aerospace & Defense Applications
- Space-Constrained Systems
- Isolated Board-Level Power

#### **Package Information**

- Surface Mountable 0.87 x 0.65 x 0.265in package
- Weight = 7.8 grams





# Not Recommended for New Designs PI31xx-00-HVMZ

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# Not Recommended for New Designs PI31xx-00-HVMZ

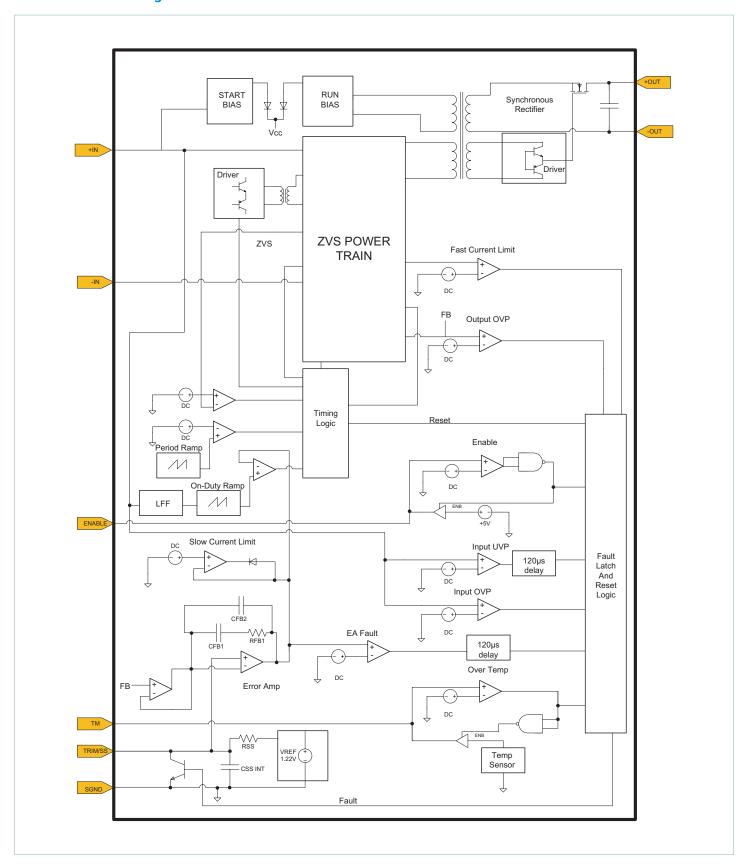
# **Order Information**

Part Number	V <sub>IN</sub>	V <sub>OUT</sub>	I <sub>OUT</sub> Max	Package	Transport Media
PI3108-00-HVMZ	16 – 50V	3.3V	10A	0.87 x 0.65 x 0.265in	TRAY
PI3109-00-HVMZ	16 – 50V	5V	10A	0.87 x 0.65 x 0.265in	TRAY
PI3106-00-HVMZ	16 – 50V	12V	4.2A	0.87 x 0.65 x 0.265in	TRAY
PI3111-00-HVMZ	16 – 50V	15V	3.33A	0.87 x 0.65 x 0.265in	TRAY
			Also Available		
PI3101-00-HVIZ	36 – 75V	3.3V	18A	0.87 x 0.65 x 0.265in	TRAY
PI3105-00-HVIZ	36 – 75V	12V	5A	0.87 x 0.65 x 0.265in	TRAY
PI3110-01-HVIZ	41 – 57V	18V	3.3A	0.87 x 0.65 x 0.265in	TRAY
PI3109-01-HVIZ	18 – 36V	5V	10A	0.87 x 0.65 x 0.265in	TRAY
PI3106-01-HVIZ	18 – 36V	12V	4.2A	0.87 x 0.65 x 0.265in	TRAY

# **Absolute Maximum Ratings**

Name	Rating
+IN to -IN Max Operating Voltage	-1.0 to 50V <sub>DC</sub> (operating)
+IN to -IN Max Peak Voltage	55V <sub>DC</sub> (non-operating, 12.5ms)
ENABLE to -IN	-0.3 to 6.0V <sub>DC</sub>
TM to -IN	-0.3 to 6.0V <sub>DC</sub>
TRIM/SS to -IN	-0.3 to 6.0V <sub>DC</sub>
+OUT to -OUT	See relevant model output section
Isolation Voltage (+IN/–IN to +OUT/–OUT)	2250V <sub>DC</sub>
Continuous Output Current	See relevant model output section
Peak Output Current	See relevant model output section
Operating Junction Temperature	−55 to 125°C
Storage Temperature	–65 to 125°C
Case Temperature During Reflow	245°C
Peak Compressive Force Applied to Case (Z-axis)	3lbs (supported by J-lead only)

### **Functional Block Diagram**



### **Pin Description**

Pin Name	Description			
+IN	Primary side positive input voltage terminals.			
-IN	Primary side negative input voltage terminals.			
ENABLE	Converter enable option, functions as 5V reference and on / off control pin. Pull low for off.			
TRIM/SS	External soft-start pin and trim function. Connect to SGND or ENABLE through resistor for trim up or trim down.			
TM	Temperature measurement output pin.			
SGND	Signal ground, primary side referenced.			
+OUT	Isolated secondary DC output voltage positive terminals.			
-OUT	Isolated secondary DC output voltage negative terminals.			

# **Package Pinout**



### **PI3108-00-HVMZ Electrical Characteristics**

Unless otherwise specified: 16V <  $V_{IN}$  < 50V, 0A <  $I_{OUT}$  < 10A,  $-55^{\circ}C$  <  $T_{CASE}$  < 100°C  $^{[a]}$ 

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
		Input Specifications				
In rout Valta as Dansa	\ /	Input Specifications	1.0	20	Ε0	\ /
Input Voltage Range	V <sub>IN</sub>	27 507	16	28	50	V <sub>DC</sub>
Input dV/dt [a]	V <sub>INDVDT</sub>	$V_{IN} = 50V$		45.0	1.0	V/µs
Input Undervoltage Turn-on	V <sub>UVON</sub>	I <sub>O</sub> = 10A	14.5	15.3	16	$V_{DC}$
Input Undervoltage Turn-off	V <sub>UVOFF</sub>	$I_0 = 10A$	13.5	14.1	15.2	$V_{DC}$
Input Undervoltage Hysteresis	V <sub>UVH</sub>	$I_0 = 10A$		1.2		$V_{DC}$
Input Overvoltage Turn-on	V <sub>OVON</sub>	$I_0 = 10A$	50	52.5	54	V <sub>DC</sub>
Input Overvoltage Turn-off	$V_{OVOFF}$	$I_{O} = 10A$	51	53.7	55	$V_{DC}$
Input Overvoltage Hysteresis	$V_{OVH}$	$I_0 = 10A$		1.2		$V_{DC}$
Input Quiescent Current	$I_Q$	$V_{IN} = 28V$ , ENABLE = $0V$		2		$mA_{DC}$
Input Idling Power	$P_{IDLE}$	$V_{IN} = 28V$ , $I_{OUT} = 0A$		2.6		W
Input Standby Power	$P_{SBY}$	V <sub>IN</sub> = 28V, ENABLE = 0V		0.048		W
Input Current Full Load	I <sub>IN</sub>	$T_{CASE}$ = 100°C, $I_{OUT}$ = 10A, $\eta_{FL}$ = 86% typical, $V_{IN}$ = 28V		1.37		$A_{DC}$
Input Reflected Ripple Current	I <sub>INRR</sub>	$L_{IN}$ = 0.47 $\mu$ H $C_{IN}$ = 100 $\mu$ F 63V electrolytic + 2 x 4.7 $\mu$ F 50V X7R ceramic		15		mApp
Recommended Ext Input Capacitance	C <sub>IN</sub>	$C_{IN}$ = 100 $\mu$ F 63V electrolytic + 2 x 4.7 $\mu$ F 50V X7R ceramic $C_{IN}$ = Cbulk + Chf		109.4		μF
		Output Specifications				
Output Voltage Set Point	V <sub>OUT</sub>	I <sub>OUT</sub> = 5A		3.3		$V_{DC}$
	.,	-0°C < T <sub>CASE</sub> < 100°C	-3		+3	%
Total Output Accuracy	$V_{OA}$	-55°C < T <sub>CASE</sub> < 0°C	-5		+3	%
Output Voltage Trim Range	V <sub>OADJ</sub>		-10		10	%
Output Current Range	I <sub>OUT</sub>				10	A <sub>DC</sub>
Overcurrent Protection	I <sub>OCP</sub>		11.0	15	20	A <sub>DC</sub>
Efficiency – Full Load	$\eta_{\sf FL}$	T <sub>CASE</sub> = 100°C, V <sub>IN</sub> = 28V	84	86		%
Efficiency – Half Load	$\eta_{HL}$	$T_{CASE} = 100^{\circ}C, V_{IN} = 28V$	80	82		%
Output OVP Set Point	V <sub>OVP</sub>	CASE 111 47 1 III	3.9	4.1	4.3	V <sub>DC</sub>
Output Ripple Voltage	V <sub>ORPP</sub>	C <sub>OUT</sub> = 6 x 10μF 10V X7R DC-20MHz	3.3	90	5	mVpp
Switching Frequency	f <sub>SW</sub>	C001 = 0 x 10 µ1 10 v X/X DC 20141112		900		kHz
Output Turn-on Delay Time	t <sub>ONDLY</sub>	$V_{IN} = V_{UVON}$ to ENABLE = 5V; $V_{IN}$ rise time < 1ms		80		ms
Output Turn-off Delay Time	t <sub>OFFDLY</sub>	$V_{IN} = V_{UVOFF}$ to ENABLE < 2.35V		375		μs
Soft-Start Ramp Time		ENABLE = 5V to 90% $V_{OUT} C_{REF} = 0$		380		
Maximum Load Capacitance	t <sub>SS</sub>	$C_{REF} = 0.22 \mu F$ , $C_{OUT} = AI$ Electrolytic		360	4700	μs μF
Load Transient Deviation	C <sub>OUT</sub>	$I_{OUT} = 50\%$ step 0.1A/ $\mu$ S $C_{OUT} = 6 \times 10 \mu$ F 10V X7R		145	4700	mV
Load Transient Recovery Time	t <sub>OVR</sub>	$I_{OUT} = 6 \times 10 \mu F 10V X/R$ $I_{OUT} = 50\% \text{ step } 0.1A/\mu S$ $C_{OUT} = 6 \times 10 \mu F 10V X/R$ $V_{OUT} \le 1\%$		100		μs
Maximum Output Power	P <sub>OUT</sub>			33		W
		Absolute Maximum Output Ratings				
Name		Rating				
+OUT to -OUT		-0.5V to 6.8V <sub>DC</sub>				
Continuous Output Current		10A <sub>DC</sub>				
Peak Output Current		20A <sub>DC</sub>				

<sup>[</sup>a] These parameters are not production tested but are guaranteed by design, characterization and correlation with statistical process control. Unless otherwise specified, ATE tests are completed at room temperature. [b] Current flow sourced by a pin has a negative sign.



# PI3108-00-HVMZ Electrical Characteristics (Cont.)

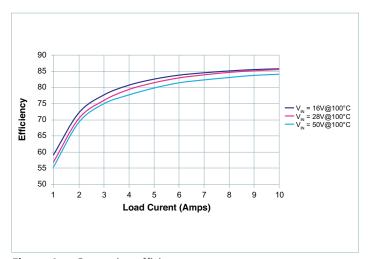
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
	I	ENABLE		I		I
DC Voltage Reference Output	V <sub>ERO</sub>		4.65	4.9	5.15	V <sub>DC</sub>
Output Current Limit [b]	I <sub>ECL</sub>	ENABLE = 3.3V	-3.3	-2.6	-1.9	mA <sub>DC</sub>
Start Up Current Limit [b]	I <sub>ESL</sub>	ENABLE = 1V	-120	-90	-60	μΑ
Module Enable Voltage	V <sub>EME</sub>		1.95	2.5	3.05	V <sub>DC</sub>
Module Disable Voltage	V <sub>EMD</sub>		1.8	2.35	2.9	$V_{DC}$
Disable Hysteresis	V <sub>EDH</sub>			150		mV
Enable Delay Time	t <sub>EE</sub>			10		μs
Disable Delay Time	t <sub>ED</sub>			10		μs
Maximum Capacitance	C <sub>EC</sub>				1500	pF
Maximum External Toggle Rate	f <sub>EXT</sub>				1	Hz
		TRIM/SS				
Trim Voltage Reference	$V_{REF}$			1.240		V <sub>DC</sub>
Internal Capacitance	C <sub>REFI</sub>			10		nF
External Capacitance	C <sub>REF</sub>				0.22	μF
Internal Resistance	R <sub>REFI</sub>			10	0.22	kΩ
mema resistance	, KELI			10		N32
		TM (Temperature Monitor)				
Temperature Coefficient [a]	TM <sub>TC</sub>			10		mV / °K
Temperature Full Range Accuracy [a]	TM <sub>ACC</sub>		-5		5	°K
Drive Capability	I <sub>TM</sub>		-100			μΑ
TM Output Setting	V <sub>TM</sub>	Ambient Temperature = 300°K		3.00		V
		Thermal Specification				
Junction Temperature Shutdown [a]	T <sub>MAX</sub>		130	135	140	°C
Junction-to-Case Thermal Impedance	$\theta_{J-C}$			3		°C / W
Case-to-Ambient Thermal Impedance	$\theta_{\text{C-A}}$	Mounted on 9in <sup>2</sup> 1oz. Cu 6 layer PCB 25°C		9.6		°C / W
		Soldering				
		MSL 5; time on floor = 48 hours			225	°C
Peak Temperature During Reflow		MSL 6; time on floor = 4 hours			245	∘℃
		NISE O, time on noor = 4 hours			243	
		Regulatory Specification				
IEC 60950-1:2005 (2nd Edition)						
EN 60950-1:2006						
IEC 61000-4-2						
UL60950-1:2007						
CAN/CSA C22.2 NO. 60950-1-07						
Recommended Input Fuse Rating	I <sub>FUSE</sub>	Fast acting LITTLEFUSE Nano <sup>2</sup> Series Fuse	4		10	А

<sup>[</sup>a] These parameters are not production tested but are guaranteed by design, characterization and correlation with statistical process control. Unless otherwise specified, ATE tests are completed at room temperature.

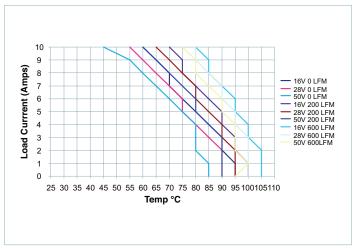
[b] Current flow sourced by a pin has a negative sign.



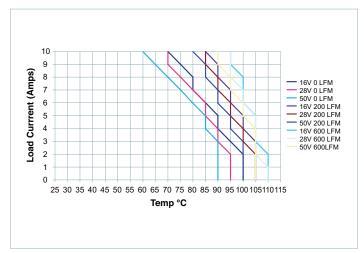
#### PI3108-00-HVMZ Electrical Characteristics (Cont.)



**Figure 1** — Conversion efficiency



**Figure 2** — Load current vs. temperature (without heat sink)



**Figure 3** — Load current vs. temperature (6.33mm heat sink)

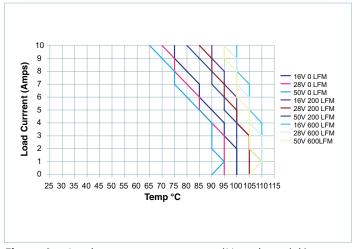
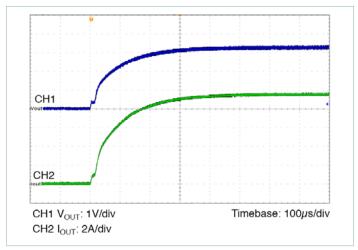
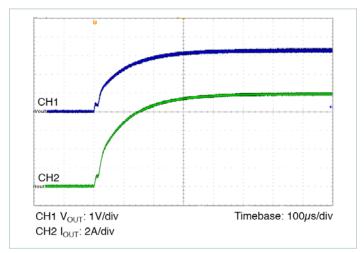


Figure 4 — Load current vs. temperature (11mm heat sink)

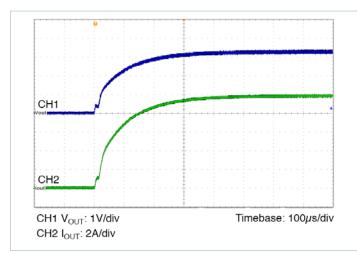


**Figure 5** — Start up,  $C_{REF} = 0$  ( $V_{IN} = 16V$ ,  $I_{OUT} = 10A$ , CR,  $C_{OUT} = 6 \times 10 \mu F X7R$  ceramic)

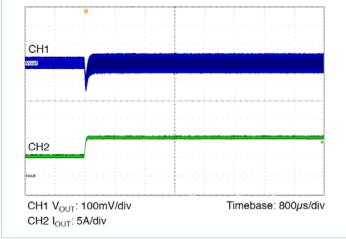


**Figure 6** — Start up,  $C_{REF} = 0$  ( $V_{IN} = 28V$ ,  $I_{OUT} = 10A$ , CR,  $C_{OUT} = 6 \times 10 \mu F$  X7R ceramic)

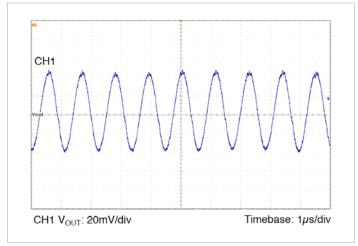
### PI3108-00-HVMZ Electrical Characteristics (Cont.)



**Figure 7** — Start up,  $C_{REF} = 0$  ( $V_{IN} = 50V$ ,  $I_{OUT} = 10A$ , CR,  $C_{OUT} = 6 \times 10 \mu F X7R$  ceramic)



**Figure 8** — Transient response ( $V_{IN} = 28V$ ,  $I_{OUT} = 5 - 10A$ , 0.1A/ $\mu$ s,  $C_{OUT} = 6 \times 10 \mu$ F X7R ceramic)



**Figure 9** — Output ripple ( $V_{IN}$  = 28V,  $I_{OUT}$  = 10A, CR,  $C_{OUT}$  = 6 x 10 $\mu$ F X7R ceramic)



**Figure 10** — Thermal image  $(V_{IN} = 28V, I_{OUT} = 10A, CR, OLFM evaluation PCB)$ 

### **PI3109-00-HVMZ Electrical Characteristics**

Unless otherwise specified:  $16V < V_{IN} < 50V$ ,  $0A < I_{OUT} < 10A$ ,  $-55^{\circ}C < T_{CASE} < 100^{\circ}C$  [a]

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
		Input Specifications				
Input Voltage Range	V <sub>IN</sub>	input specifications	16	28	50	\/
Input dV/dt [a]		$V_{IN} = 50V$	10	20	1.0	V <sub>DC</sub> V/µs
Input Undervoltage Turn-on	V <sub>INDVDT</sub> V <sub>UVON</sub>	$I_{O} = 10A$	14.5	15.3	1.0	· ·
Input Undervoltage Turn-off	V <sub>UVOFF</sub>	$I_0 = 10A$ $I_0 = 10A$	13.5	14.1	15.2	V <sub>DC</sub>
Input Undervoltage Hysteresis			13.3	1.2	13.2	V <sub>DC</sub>
Input Overvoltage Turn-on	V <sub>UVH</sub>	I <sub>O</sub> = 10A I <sub>O</sub> = 10A	50.0	52.5	54	
Input Overvoltage Turn-off	V <sub>OVON</sub>	-	50.0	53.7	55	V <sub>DC</sub>
Input Overvoltage Hysteresis	V <sub>OVOFF</sub>	I <sub>O</sub> = 10A	31		55	V <sub>DC</sub>
	V <sub>OVH</sub>	I <sub>O</sub> = 10A		1.2		V <sub>DC</sub>
Input Quiescent Current	IQ	$V_{IN} = 28V$ , ENABLE = $0V$		2		mA <sub>DC</sub>
Input Idling Power	P <sub>IDLE</sub>	$V_{IN} = 28V$ , $I_{OUT} = 0A$		3.5		W
Input Standby Power	P <sub>SBY</sub>	$V_{IN} = 28V$ , ENABLE = 0V		0.056		W
Input Current Full Load	I <sub>IN</sub>	$T_{CASE}$ = 100°C, $I_{OUT}$ = 10A, $\eta_{FL}$ = 88% typical, $V_{IN}$ = 28V		2.03		A <sub>DC</sub>
Input Reflected Ripple Current	I <sub>INRR</sub>	$L_{\text{IN}}$ = 0.47 $\mu$ H $C_{\text{IN}}$ = 100 $\mu$ F 63V electrolytic + 2 x 4.7 $\mu$ F 50V X7R ceramic		13		mApp
Recommended Ext Input Capacitance	$C_IN$	$C_{IN}$ = 100 $\mu$ F 63V electrolytic + 2 x 4.7 $\mu$ F 50V X7R ceramic $C_{IN}$ = Cbulk + Chf		109.4		μF
'		Output Specifications				
Output Voltage Set Point	V <sub>OUT</sub>	I <sub>OUT</sub> = 5A		5.0		$V_{DC}$
		$-0^{\circ}\text{C} < \text{T}_{\text{CASE}} < 100^{\circ}\text{C}$	-3		+3	%
Total Output Accuracy	$V_{OA}$	-55°C < T <sub>CASE</sub> < 0°C	-5		+3	%
Output Voltage Trim Range	V <sub>OADJ</sub>	C. GE	-20		10	%
Output Current Range	I <sub>OUT</sub>				10	A <sub>DC</sub>
Overcurrent Protection	I <sub>OCP</sub>		10.8	15	20	A <sub>DC</sub>
Efficiency – Full Load	η <sub>FI</sub>	T <sub>CASE</sub> = 100°C, V <sub>IN</sub> = 28V	86	88		%
Efficiency – Half Load	η <sub>HL</sub>	$T_{CASE} = 100^{\circ}C$ , $V_{IN} = 28V$	83.5	85.5		%
Output OVP Set Point	V <sub>OVP</sub>	CASE 7 IIV	6.0	6.3	6.6	V <sub>DC</sub>
Output Ripple Voltage	V <sub>ORPP</sub>	C <sub>OUT</sub> = 6 x 10μF 10V X7R DC-20MHz		135		mVpp
Switching Frequency	f <sub>SW</sub>	-001		900		kHz
Output Turn-on Delay Time	t <sub>ONDLY</sub>	$V_{IN} = V_{LIVON}$ to ENABLE = 5V; $V_{IN}$ rise time < 1ms		80		ms
Output Turn-off Delay Time	t <sub>OFFDLY</sub>	$V_{IN} = V_{UVOFF}$ to ENABLE < 2.35V		375		μs
Soft-Start Ramp Time	t <sub>SS</sub>	ENABLE = 5V to 90% V <sub>OUT</sub> C <sub>REF</sub> = 0		230		μs
Maximum Load Capacitance	C <sub>OUT</sub>	$C_{REF} = 0.22 \mu F$ , $C_{OUT} = Al$ Electrolytic		230	4700	μF
Load Transient Deviation	V <sub>ODV</sub>	$I_{OUT} = 50\%$ step 0.1A/ $\mu$ S $C_{OUT} = 6 \times 10 \mu F$ 10V X7R		90	1700	mV
Load Transient Recovery Time	t <sub>OVR</sub>	$I_{OUT} = 50\%$ step 0.1A/ $\mu$ S $C_{OUT} = 6 \times 10 \mu$ F 10V X7R $V_{OUT} \le 1\%$		100		μs
Maximum Output Power	P <sub>OUT</sub>			50		W
		Absolute Maximum Output Ratings				
Name		Rating				
+OUT to -OUT		-0.5V to 6.8V <sub>DC</sub>				
Continuous Output Current		10A <sub>DC</sub>				
Peak Output Current		20A <sub>DC</sub>				

<sup>[</sup>a] These parameters are not production tested but are guaranteed by design, characterization and correlation with statistical process control. Unless otherwise specified, ATE tests are completed at room temperature. <sup>[b]</sup> Current flow sourced by a pin has a negative sign.



# PI3109-00-HVMZ Electrical Characteristics (Cont.)

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
25.11 2.1		ENABLE	4.65	4.0	E 45	
DC Voltage Reference Output	V <sub>ERO</sub>		4.65	4.9	5.15	V <sub>DC</sub>
Output Current Limit [b]	I <sub>ECL</sub>	ENABLE = 3.3V	-3.3	-2.6	-1.9	mA <sub>DC</sub>
Start Up Current Limit [b]	I <sub>ESL</sub>	ENABLE = 1V	-120	-90	-60	μΑ
Module Enable Voltage	V <sub>EME</sub>		1.95	2.5	3.05	V <sub>DC</sub>
Module Disable Voltage	V <sub>EMD</sub>		1.8	2.35	2.9	V <sub>DC</sub>
Disable Hysteresis	V <sub>EDH</sub>			150		mV
Enable Delay Time	t <sub>EE</sub>			10		μs
Disable Delay Time	t <sub>ED</sub>			10		μs
Maximum Capacitance	C <sub>EC</sub>				1500	pF
Maximum External Toggle Rate	f <sub>EXT</sub>				1	Hz
		TRIM/SS				
Trim Voltage Reference	$V_{REF}$			1.240		V <sub>DC</sub>
Internal Capacitance	C <sub>REFI</sub>			10		nF
External Capacitance	C <sub>REF</sub>				0.22	μF
Internal Resistance	R <sub>REFI</sub>			10		kΩ
	KEIT					
	I	TM (Temperature Monitor)			I	I
Temperature Coefficient [a]	TM <sub>TC</sub>			10		mV / °K
Temperature Full Range Accuracy [a]	TM <sub>ACC</sub>		-5		5	°K
Drive Capability	I <sub>TM</sub>		-100			μΑ
TM Output Setting	V <sub>TM</sub>	Ambient Temperature = 300°K		3.00		V
		Thermal Specification				
Junction Temperature Shutdown [a]	T <sub>MAX</sub>		130	135	140	°C
Junction-to-Case Thermal Impedance	$\theta_{J-C}$			3		°C / W
Case-to-Ambient Thermal Impedance	$\theta_{\text{C-A}}$	Mounted on 9in <sup>2</sup> 1oz. Cu 6 layer PCB 25°C		9.1		°C / W
		Soldering				
		MSL 5; time on floor = 48 hours			225	°C
Peak Temperature During Reflow		MSL 6; time on floor = 4 hours			245	°C
		Regulatory Specification				
IEC 60950-1:2005 (2nd Edition)						
EN 60950-1:2006						
IEC 61000-4-2						
UL60950-1:2007						
CAN/CSA C22.2 NO. 60950-1-07						
Recommended Input Fuse Rating	I <sub>FUSE</sub>	Fast acting LITTLEFUSE Nano <sup>2</sup> Series Fuse	4		10	А

<sup>[</sup>a] These parameters are not production tested but are guaranteed by design, characterization and correlation with statistical process control. Unless otherwise specified, ATE tests are completed at room temperature.

[b] Current flow sourced by a pin has a negative sign.



#### PI3109-00-HVMZ Electrical Characteristics (Cont.)

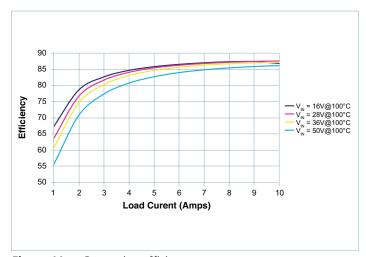


Figure 11 — Conversion efficiency

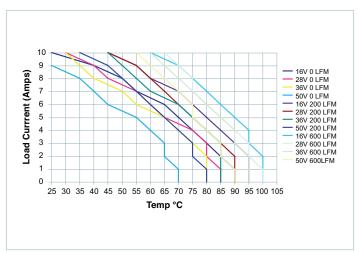


Figure 12 — Load current vs. temperature (without heat sink)

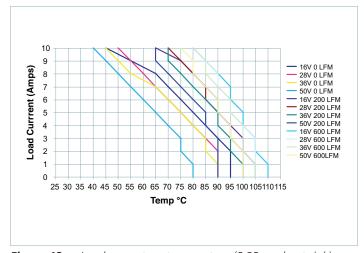


Figure 13 — Load current vs. temperature (6.33mm heat sink)

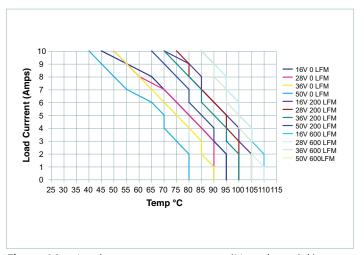


Figure 14 — Load current vs. temperature (11mm heat sink)

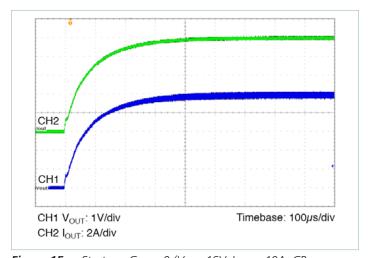


Figure 15 — Start up,  $C_{REF} = 0$  ( $V_{IN} = 16V$ ,  $I_{OUT} = 10A$ , CR,  $C_{OUT} = 6 \times 10 \mu F$  X7R ceramic)

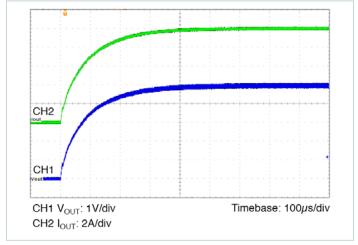
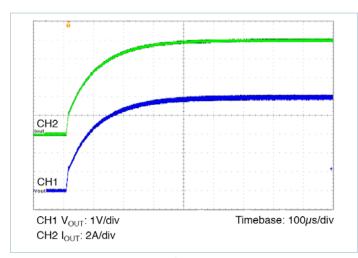
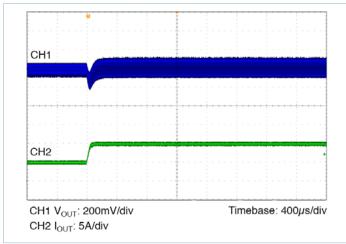


Figure 16 — Start up,  $C_{REF} = 0$  ( $V_{IN} = 28V$ ,  $I_{OUT} = 10A$ , CR,  $C_{OUT} = 6 \times 10 \mu F$  X7R ceramic)

### PI3109-00-HVMZ Electrical Characteristics (Cont.)



**Figure 17** — Start up,  $C_{REF} = 0$  ( $V_{IN} = 50V$ ,  $I_{OUT} = 10A$ , CR,  $C_{OUT} = 6 \times 10 \mu F$  X7R ceramic)



**Figure 18** — Transient response ( $V_{IN} = 28V$ ,  $I_{OUT} = 5 - 10A$ ,  $0.1A/\mu s$ ,  $C_{OUT} = 6 \times 10 \mu F$  X7R ceramic)

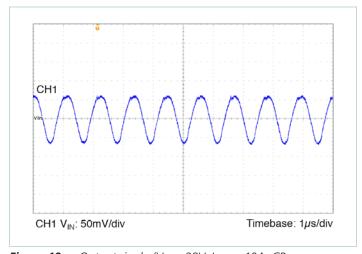


Figure 19 — Output ripple ( $V_{IN} = 28V$ ,  $I_{OUT} = 10A$ , CR,  $C_{OUT} = 6 \times 10 \mu F X7R$  ceramic)



**Figure 20** — Thermal image ( $V_{IN}$  = 28V,  $I_{OUT}$  = 10A, CR, OLFM evaluation PCB)

### **PI3106-00-HVMZ Electrical Characteristics**

Unless otherwise specified:  $16V < V_{IN} < 50V$ ,  $0A < I_{OUT} < 4.2A$ ,  $-55^{\circ}C < T_{CASE} < 100^{\circ}C$  [a]

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
		Input Specifications				
Input Voltage Range	V <sub>IN</sub>	input specifications	16	28	50	\/
Input dV/dt [a]	***	$V_{IN} = 50V$	10	20	1.0	V <sub>DC</sub> V/µs
Input Undervoltage Turn-on	V <sub>INDVDT</sub> V <sub>UVON</sub>	$I_0 = 4.2A$	14.5	15.4	1.0	
Input Undervoltage Turn-off	V <sub>UVOFF</sub>	$I_0 = 4.2A$ $I_0 = 4.2A$	13.5	14.4	15.2	V <sub>DC</sub>
Input Undervoltage Hysteresis		$I_0 = 4.2A$ $I_0 = 4.2A$	13.3	1.0	13.2	V <sub>DC</sub>
Input Overvoltage Turn-on	V <sub>UVH</sub>		50	52.3	54	
Input Overvoltage Turn-off	V <sub>OVON</sub>	$I_0 = 4.2A$ $I_0 = 4.2A$	51	53.5	55	V <sub>DC</sub>
Input Overvoltage Hysteresis	V <sub>OVOFF</sub>	$I_0 = 4.2A$	31		33	V <sub>DC</sub>
	V <sub>OVH</sub>	0		1.2		V <sub>DC</sub>
Input Quiescent Current	I <sub>Q</sub>	$V_{IN} = 28V$ , ENABLE = $0V$		2		mA <sub>DC</sub>
Input Idling Power	P <sub>IDLE</sub>	$V_{IN} = 28V$ , $I_{OUT} = 0A$		3.5		W
Input Standby Power	P <sub>SBY</sub>	$V_{IN} = 28V$ , ENABLE = $0V$		0.056		W
Input Current Full Load	I <sub>IN</sub>	$T_{CASE}$ = 100°C, $I_{OUT}$ = 4.2A, $\eta_{FL}$ = 88% typical, $V_{IN}$ = 28V		2.045		$A_{DC}$
Input Reflected Ripple Current	I <sub>INRR</sub>	$L_{\text{IN}}$ = 0.47 $\mu$ H $C_{\text{IN}}$ = 100 $\mu$ F 63V electrolytic + 2 x 4.7 $\mu$ F 50V X7R ceramic		13		mApp
Recommended Ext Input Capacitance	$C_IN$	$C_{IN}$ = 100 $\mu$ F 63V electrolytic + 2 x 4.7 $\mu$ F 50V X7R ceramic $C_{IN}$ = Cbulk + Chf		109.4		μF
		Output Specifications				
Output Voltage Set Point	V <sub>OUT</sub>	I <sub>OUT</sub> = 2.1A		12.0		V <sub>DC</sub>
		$-0^{\circ}\text{C} < \text{T}_{\text{CASF}} < 100^{\circ}\text{C}$	-3		+3	%
Total Output Accuracy	$V_{OA}$	-55°C < T <sub>CASE</sub> < 0°C	-5		+3	%
Output Voltage Trim Range	V <sub>OADJ</sub>		-20		10	%
Output Current Range	I <sub>OUT</sub>				4.2	A <sub>DC</sub>
Overcurrent Protection	I <sub>OCP</sub>		4.6	6.8	12	A <sub>DC</sub>
Efficiency – Full Load	$\eta_{\sf Fl}$	T <sub>CASE</sub> = 100°C, V <sub>IN</sub> = 28V	86	88		%
Efficiency – Half Load	$\eta_{HL}$	T <sub>CASE</sub> = 100°C, V <sub>IN</sub> = 28V	83	85		%
Output OVP Set Point	V <sub>OVP</sub>	Cross IIV	13.8	14.6	15.3	V <sub>DC</sub>
Output Ripple Voltage	V <sub>ORPP</sub>	C <sub>OUT</sub> = 6 x 2.2µF 16V X7R DC-20MHz		150		mVpp
Switching Frequency	f <sub>SW</sub>			900		kHz
Output Turn-on Delay Time	t <sub>ONDLY</sub>	$V_{IN} = V_{UVON}$ to ENABLE = 5V; $V_{IN}$ rise time < 1ms		80		ms
Output Turn-off Delay Time	t <sub>OFFDLY</sub>	$V_{IN} = V_{UVOFF}$ to ENABLE < 2.35V		375		μs
Soft-Start Ramp Time	t <sub>SS</sub>	ENABLE = 5V to 90% V <sub>OUT</sub> C <sub>REF</sub> = 0		230		μs
Maximum Load Capacitance	C <sub>OUT</sub>	$C_{REF} = 0.22 \mu F$ , $C_{OUT} = AI$ Electrolytic		250	1000	μF
Load Transient Deviation	V <sub>ODV</sub>	$I_{OUT} = 50\%$ step 0.1A/ $\mu$ S $C_{OUT} = 6 \times 2.2 \mu$ F 16V X7R		360		mV
Load Transient Recovery Time	t <sub>OVR</sub>	$I_{OUT} = 50\%$ step 0.1A/ $\mu$ S $C_{OUT} = 6 \times 2.2 \mu$ F 16V X7R $V_{OUT} \le 1\%$		100		μs
Maximum Output Power	P <sub>OUT</sub>			50		W
		Absolute Maximum Output Ratings				
Name		Rating				
+OUT to -OUT		-0.5V to 16V <sub>DC</sub>				
Continuous Output Current		4.2A <sub>DC</sub>				
Peak Output Current		12A <sub>DC</sub>				

<sup>[</sup>a] These parameters are not production tested but are guaranteed by design, characterization and correlation with statistical process control. Unless otherwise specified, ATE tests are completed at room temperature. <sup>[b]</sup> Current flow sourced by a pin has a negative sign.



# PI3106-00-HVMZ Electrical Characteristics (Cont.)

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
DC Valtage Defende a Outrot	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	ENABLE	4.65	4.0	F 1F	
DC Voltage Reference Output	V <sub>ERO</sub>	ENABLE 2 2V	4.65	4.9	5.15	V <sub>DC</sub>
Output Current Limit [b]	I <sub>ECL</sub>	ENABLE = 3.3V	-3.3	-2.6	-1.9	mA <sub>DC</sub>
Start Up Current Limit [b]	I <sub>ESL</sub>	ENABLE = 1V	-120	-90	-60	μA
Module Enable Voltage	V <sub>EME</sub>		1.95	2.5	3.05	V <sub>DC</sub>
Module Disable Voltage	V <sub>EMD</sub>		1.8	2.35	2.9	V <sub>DC</sub>
Disable Hysteresis	V <sub>EDH</sub>			150		mV
Enable Delay Time	t <sub>EE</sub>			10		μs
Disable Delay Time	t <sub>ED</sub>			10		μs
Maximum Capacitance	C <sub>EC</sub>				1500	pF
Maximum External Toggle Rate	f <sub>EXT</sub>				1	Hz
		TRIM/SS				
Trim Voltage Reference	V <sub>REF</sub>			1.235		V <sub>DC</sub>
Internal Capacitance	C <sub>REFI</sub>			10		nF
External Capacitance	C <sub>REF</sub>				0.22	μF
Internal Resistance	R <sub>REFI</sub>			10		kΩ
	KEIT					
		TM (Temperature Monitor)				I
Temperature Coefficient [a]	TM <sub>TC</sub>			10		mV / °K
Temperature Full Range Accuracy [a]	TM <sub>ACC</sub>		-5		5	°K
Drive Capability	I <sub>TM</sub>		-100			μΑ
TM Output Setting	V <sub>TM</sub>	Ambient Temperature = 300°K		3.00		V
		Thermal Specification				
Junction Temperature Shutdown [a]	T <sub>MAX</sub>		130	135	140	°C
Junction-to-Case Thermal Impedance	$\theta_{\text{J-C}}$			3		°C / W
Case-to-Ambient Thermal Impedance	$\theta_{\text{C-A}}$	Mounted on 9in <sup>2</sup> 1oz. Cu 6 layer PCB 25°C		8.2		°C / W
		Soldering				
		MSL 5; time on floor = 48 hours			225	°C
Peak Temperature During Reflow		MSL 6; time on floor = $4 \text{ hours}$			245	°C
		inst of time of floor = 1 floors			213	
		Regulatory Specification	'			
IEC 60950-1:2005 (2nd Edition)						
EN 60950-1:2006						
IEC 61000-4-2						
UL60950-1:2007						
CAN/CSA C22.2 NO. 60950-1-07						
Recommended Input Fuse Rating	I <sub>FUSE</sub>	Fast acting LITTLEFUSE Nano <sup>2</sup> Series Fuse	4		10	А

<sup>[</sup>a] These parameters are not production tested but are guaranteed by design, characterization and correlation with statistical process control. Unless otherwise specified, ATE tests are completed at room temperature.

[b] Current flow sourced by a pin has a negative sign.



#### PI3106-00-HVMZ Electrical Characteristics (Cont.)

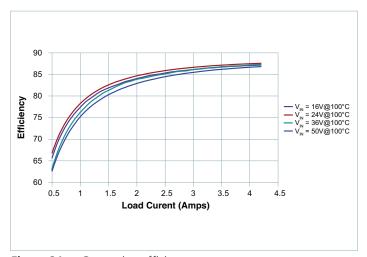


Figure 21 — Conversion efficiency

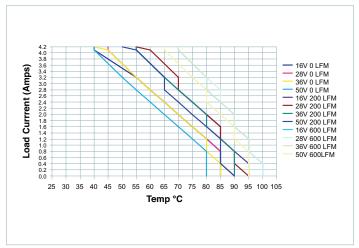
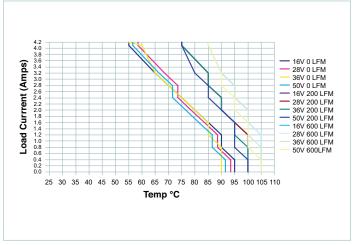


Figure 22 — Load current vs. temperature (without heat sink)



**Figure 23** — Load current vs. temperature (6.3mm heat sink)

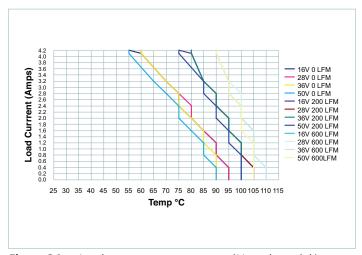
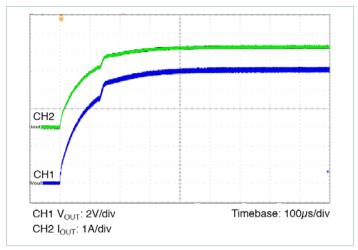
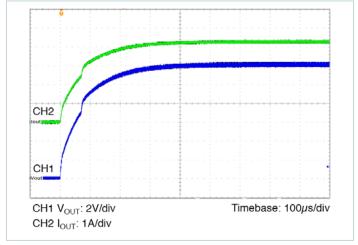


Figure 24 — Load current vs. temperature (11mm heat sink)

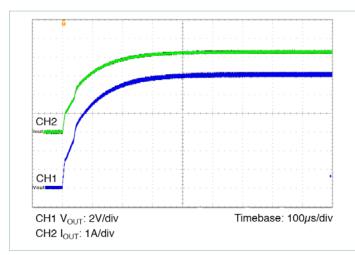


**Figure 25** — Start up,  $C_{REF} = 0$  ( $V_{IN} = 16V$ ,  $I_{OUT} = 4.2A$ , CR,  $C_{OUT} = 6 \times 2.2 \mu F$  X7R ceramic)

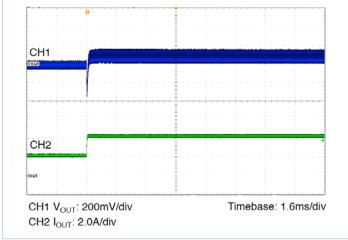


**Figure 26** — Start up,  $C_{REF} = 0$  ( $V_{IN} = 28V$ ,  $I_{OUT} = 4.2A$ , CR,  $C_{OUT} = 6 \times 2.2 \mu F$  X7R ceramic)

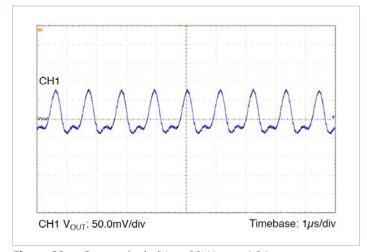
### PI3106-00-HVMZ Electrical Characteristics (Cont.)



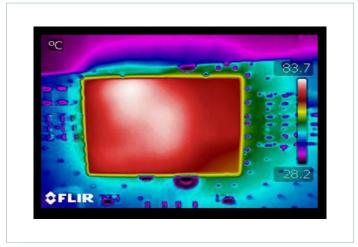
**Figure 27** — Start up,  $C_{REF} = 0$  ( $V_{IN} = 50V$ ,  $I_{OUT} = 4.2A$ , CR,  $C_{OUT} = 6 \times 2.2 \mu F$  X7R ceramic)



**Figure 28** — Transient response ( $V_{IN} = 28V I_{OUT} = 2.1 - 4.2A$ , 0.1A/ $\mu$ s,  $C_{OUT} = 6 \times 2.2 \mu$ F X7R ceramic)



**Figure 29** — Output ripple ( $V_{IN} = 28V I_{OUT} = 4.2A$ ,  $C_{OUT} = 6 \times 2.2 \mu F X7R$  ceramic)



**Figure 30** — Thermal image ( $V_{IN} = 28V$ ,  $I_{OUT} = 4.2A$ , CR, OLFM evaluation PCB)

#### **PI3111-00-HVMZ Electrical Characteristics**

Unless otherwise specified:  $16V < V_{IN} < 50V$ ,  $0A < I_{OUT} < 3.3A$ ,  $-55^{\circ}C < T_{CASE} < 100^{\circ}C$  [a]

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
		Input Specifications				
Input Voltage Range	V <sub>IN</sub>	input specifications	16	28	50	\/
Input dV/dt [a]		V <sub>IN</sub> = 50V	10	20	1.0	V <sub>DC</sub> V/µs
Input Undervoltage Turn-on	V <sub>INDVDT</sub>		14.5	15.4	1.0	· '
1 3	V <sub>UVON</sub>	I <sub>0</sub> = 3.3A				V <sub>DC</sub>
Input Undervoltage Turn-off	V <sub>UVOFF</sub>	I <sub>0</sub> = 3.3A	13.5	14.3	15.2	V <sub>DC</sub>
Input Undervoltage Hysteresis	V <sub>UVH</sub>	I <sub>O</sub> = 3.3A	ГО	1.1	F.4	V <sub>DC</sub>
Input Overvoltage Turn-on	V <sub>OVON</sub>	I <sub>0</sub> = 3.3A	50	52.4	54	V <sub>DC</sub>
Input Overvoltage Turn-off	V <sub>OVOFF</sub>	I <sub>0</sub> = 3.3A	51	53.5	55	V <sub>DC</sub>
Input Overvoltage Hysteresis	V <sub>OVH</sub>	I <sub>0</sub> = 3.3A		1.1		V <sub>DC</sub>
Input Quiescent Current	IQ	$V_{IN} = 28V$ , ENABLE = $0V$		2		mA <sub>DC</sub>
Input Idling Power	P <sub>IDLE</sub>	$V_{IN} = 28V$ , $I_{OUT} = 0A$		4.1		W
Input Standby Power	P <sub>SBY</sub>	$V_{IN} = 28V$ , ENABLE = $0V$		0.056		W
Input Current Full Load	I <sub>IN</sub>	$T_{CASE}$ = 100°C, $I_{OUT}$ = 3.3A, $\eta_{FL}$ = 87.5% typical, $V_{IN}$ = 28V		2.039		$A_{DC}$
Input Reflected Ripple Current	I <sub>INRR</sub>	$L_{IN}$ = 0.47μH $C_{IN}$ = 100μF 63V electrolytic + 2 x 4.7μF 50V X7R ceramic		13		mApp
Recommended Ext Input Capacitance	$C_IN$	$C_{IN}$ = 100 $\mu$ F 63V electrolytic + 2 x 4.7 $\mu$ F 50V X7R ceramic $C_{IN}$ = Cbulk + Chf		109.4		μF
		Output Specifications				
Output Voltage Set Point	V <sub>OUT</sub>	I <sub>OUT</sub> = 1.65A		15.0		V <sub>DC</sub>
	.,	-0°C < T <sub>CASE</sub> < 100°C	-3		+3	%
Total Output Accuracy	$V_{OA}$	-55°C < T <sub>CASE</sub> < 0°C	-5		+3	%
Output Voltage Trim Range	V <sub>OADJ</sub>		-20		10	%
Output Current Range	I <sub>OUT</sub>				3.3	A <sub>DC</sub>
Overcurrent Protection	I <sub>OCP</sub>		3.8	5.6	9.6	A <sub>DC</sub>
Efficiency – Full Load	$\eta_{\text{Fl}}$	$T_{CASE} = 100^{\circ}C, V_{IN} = 28V$	85.5	87.5		%
Efficiency – Half Load	η <sub>HL</sub>	$T_{CASE} = 100^{\circ}C$ , $V_{IN} = 28V$	82.3	84.3		%
Output OVP Set Point	V <sub>OVP</sub>	CASE 7 IIV	17.6	18.2	18.8	V <sub>DC</sub>
Output Ripple Voltage	V <sub>ORPP</sub>	C <sub>OUT</sub> = 6 x 2.2μF 16V X7R DC-20MHz		275		mVpp
Switching Frequency	f <sub>SW</sub>	e001		900		kHz
Output Turn-on Delay Time	t <sub>ONDLY</sub>	$V_{IN} = V_{UVON}$ to ENABLE = 5V; $V_{IN}$ rise time < 1ms		80		ms
Output Turn-off Delay Time	t <sub>OFFDLY</sub>	$V_{IN} = V_{UVOFF}$ to ENABLE < 2.35V		375		μs
Soft-Start Ramp Time	t <sub>SS</sub>	ENABLE = 5V to 90% V <sub>OUT</sub> C <sub>REF</sub> = 0		230		μs
Maximum Load Capacitance	C <sub>OUT</sub>	$C_{REF} = 0.22 \mu F$ , $C_{OUT} = Al$ Electrolytic		230	1000	μF
Load Transient Deviation	V <sub>ODV</sub>	$I_{OUT} = 50\%$ step 0.1A/ $\mu$ S $C_{OUT} = 6 \times 2.2 \mu$ F 16V X7R		375	1000	mV
Load Transient Recovery Time	t <sub>OVR</sub>	$I_{OUT} = 50\%$ step 0.1A/ $\mu$ S $C_{OUT} = 6 \times 2.2 \mu$ F 16V X7R $V_{OUT} \le 1\%$		100		μs
Maximum Output Power	P <sub>OUT</sub>			50		W
		Absolute Maximum Output Ratings				
Name		Rating				
+OUT to -OUT		-0.5V to 20V <sub>DC</sub>				
Continuous Output Current		3.3A <sub>DC</sub>				
Peak Output Current		9.6A <sub>DC</sub>				

<sup>[</sup>a] These parameters are not production tested but are guaranteed by design, characterization and correlation with statistical process control. Unless otherwise specified, ATE tests are completed at room temperature. <sup>[b]</sup> Current flow sourced by a pin has a negative sign.



# PI3111-00-HVMZ Electrical Characteristics (Cont.)

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
DC Valtage Defende a Outrot	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	ENABLE	4.65	4.0	F 1F	\ \/
DC Voltage Reference Output	V <sub>ERO</sub>	ENABLE 2 2V	4.65	4.9	5.15	V <sub>DC</sub>
Output Current Limit [b]	I <sub>ECL</sub>	ENABLE = 3.3V	-3.3	-2.6	-1.9	mA <sub>DC</sub>
Start Up Current Limit [b]	I <sub>ESL</sub>	ENABLE = 1V	-120	-90	-60	μΑ
Module Enable Voltage	V <sub>EME</sub>		1.95	2.5	3.05	V <sub>DC</sub>
Module Disable Voltage	V <sub>EMD</sub>		1.8	2.35	2.9	V <sub>DC</sub>
Disable Hysteresis	V <sub>EDH</sub>			150		mV
Enable Delay Time	t <sub>EE</sub>			10		μs
Disable Delay Time	t <sub>ED</sub>			10		μs
Maximum Capacitance	C <sub>EC</sub>				1500	pF
Maximum External Toggle Rate	f <sub>EXT</sub>				1	Hz
		TRIM/SS				
Trim Voltage Reference	V <sub>REF</sub>			1.230		V <sub>DC</sub>
Internal Capacitance	C <sub>REFI</sub>			10		nF
External Capacitance	C <sub>REF</sub>				0.22	μF
Internal Resistance	R <sub>REFI</sub>			10		kΩ
	KEIT					
		TM (Temperature Monitor)				I
Temperature Coefficient [a]	TM <sub>TC</sub>			10		mV / °K
Temperature Full Range Accuracy [a]	TM <sub>ACC</sub>		-5		5	°K
Drive Capability	I <sub>TM</sub>		-100			μΑ
TM Output Setting	V <sub>TM</sub>	Ambient Temperature = 300°K		3.00		V
		Thermal Specification				
Junction Temperature Shutdown [a]	T <sub>MAX</sub>		130	135	140	°C
Junction-to-Case Thermal Impedance	$\theta_{\text{J-C}}$			3		°C / W
Case-to-Ambient Thermal Impedance	θс-А	Mounted on 9in <sup>2</sup> 1oz. Cu 6 layer PCB 25°C		9.4		°C / W
		Soldering				
		MSL 5; time on floor = 48 hours			225	°C
Peak Temperature During Reflow		MSL 6; time on floor = $4 \text{ hours}$			245	°C
		NSE O, LINE ON HOOK = 4 HOOKS			2-73	
		Regulatory Specification	'			
IEC 60950-1:2005 (2nd Edition)						
EN 60950-1:2006						
IEC 61000-4-2						
UL60950-1:2007						
CAN/CSA C22.2 NO. 60950-1-07						
Recommended Input Fuse Rating	I <sub>FUSE</sub>	Fast acting LITTLEFUSE Nano <sup>2</sup> Series Fuse	4		10	А

<sup>[</sup>a] These parameters are not production tested but are guaranteed by design, characterization and correlation with statistical process control. Unless otherwise specified, ATE tests are completed at room temperature.

[b] Current flow sourced by a pin has a negative sign.



#### PI3111-00-HVMZ Electrical Characteristics (Cont.)

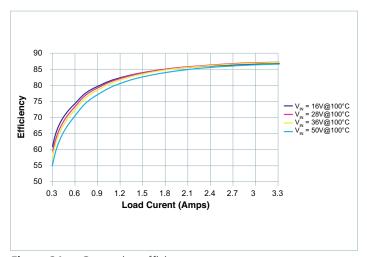


Figure 31 — Conversion efficiency

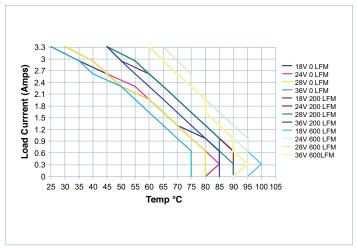


Figure 32 — Load current vs. temperature (without heat sink)

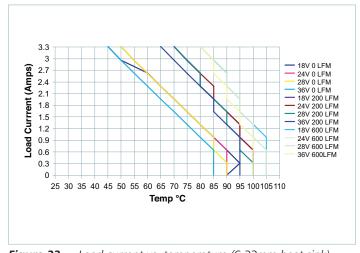


Figure 33 — Load current vs. temperature (6.33mm heat sink)

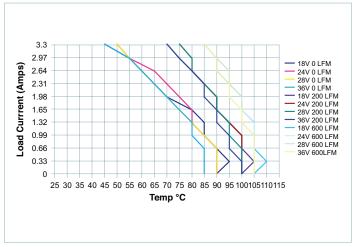
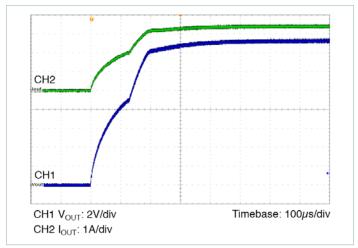
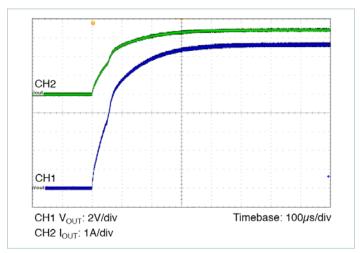


Figure 34 — Load current vs. temperature (11mm heat sink)

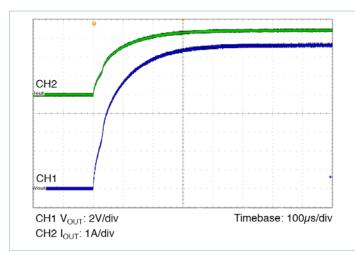


**Figure 35** — Start up,  $C_{REF} = 0$  ( $V_{IN} = 16V$ ,  $I_{OUT} = 3.3A$ , CR,  $C_{OUT} = 6 \times 2.2 \mu F X7R$  ceramic)

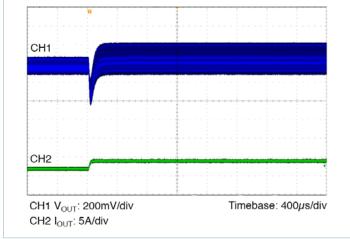


**Figure 36** — Start up,  $C_{REF} = 0$  ( $V_{IN} = 28V$ ,  $I_{OUT} = 3.3A$ , CR,  $C_{OUT} = 6 \times 2.2 \mu F X7R$  ceramic)

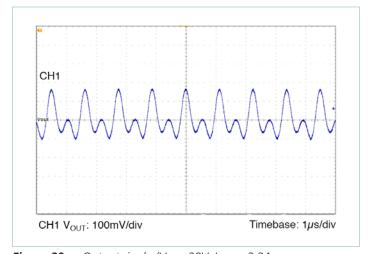
# PI3111-00-HVMZ Electrical Characteristics (Cont.)



**Figure 37** — Start up,  $C_{REF} = 0$  ( $V_{IN} = 50V$ ,  $I_{OUT} = 3.3A$ , CR,  $C_{OUT} = 6 \times 2.2 \mu F$  X7R ceramic)



**Figure 38** — Transient response ( $V_{IN} = 28V$ ,  $I_{OUT} = 1.65 - 3.3A$ ,  $0.1A/\mu s$ ,  $C_{OUT} = 6 \times 2.2 \mu F$  X7R ceramic)

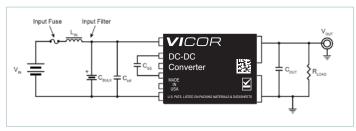


**Figure 39** — Output ripple ( $V_{IN} = 28V$ ,  $I_{OUT} = 3.3A$ ,  $C_{OUT} = 6 \times 2.2 \mu F X7R$  ceramic)



**Figure 40** — Thermal image ( $V_{IN} = 28V$ ,  $I_{OUT} = 3.33A$ , CR, OLFM Evaluation PCB)

#### **Functional Description**



**Figure 41** — PI31xx-00-HVMZ shown with system fuse, filter, decoupling and extended soft start

#### Input Power Pins IN(+) and IN(-)

The input power pins on the PI31xx-00-HVMZ are connected to the input power source which can range from  $16 - 50V_{DC}$ . Under surge conditions, the PI31xx-00-HVMZ can withstand up to 55V<sub>DC</sub> for 12.5ms without incurring damage. The user should take care to avoid driving the input rails above the specified ratings. Since the PI31xx-00-HVMZ is designed with high reliability in mind, the input pins are continuously monitored. If the applied voltage exceeds the input overvoltage trip point (typically 53.5V) the conversion process shall be terminated immediately. The converter initiates soft start automatically within 80ms after the input voltage is reduced back to the appropriate value. The input pins do not have reverse-polarity protection. If the PI31xx-00-HVMZ is operated in an environment where reverse polarity is a concern, the user should consider using a polarity protection device such as a suitably rated diode. To avoid the high losses of using a diode, the user should consider the much higher efficiency family of intelligent Cool-ORing® solutions that can be used in reverse-polarity applications. Information is available at vicorpower.com.

The PI31xx-00-HVMZ will draw nearly zero current until the input voltage reaches the internal start up threshold. If the ENABLE pin is not pulled low by external circuitry, the output voltage will begin rising to its final output value about 80ms after the input UV lockout releases. This will occur automatically even if the ENABLE pin is floating.

To help keep the source impedance low, the input to the PI31xx-00-HVMZ should be bypassed with (2)  $4.7\mu$ F 50V ceramic capacitors of X7R dielectric in parallel with a low Q  $100\mu$ F 63V electrolytic capacitor. To reduce EMI and reflected ripple current, a series inductor of  $0.2-0.47\mu$ H can be added. The input traces to the module should be low impedance configured in such a manner as to keep stray inductance minimized.

#### **ENABLE**

The ENABLE pin serves as a multi-function pin for the PI31xx-00-HVMZ. During normal operation, it outputs the on-board 4.9V regulator which can be used for trimming the module up. The ENABLE pin can also be used as a remote enable pin either from the secondary via an optocoupler and an external isolated bias supply or from the primary side through a small-signal transistor, FET, or any device that sinks 3.3mA, minimum.

If the ENABLE pin is lower than 2.35V typical, the converter will be held off or shut down if already operating. A third feature is offered in that during a fault condition, such as output OVP, input UV or OV, or output current limit, the ENABLE pin is pulled low internally. This can be used as a signal to the user that a fault has occurred. Whenever the ENABLE pin is pulled low, the TRIM/SS pin follows, resetting the internal and external soft-start circuitry. All faults will pull ENABLE low including overtemperature. If increased turn-on delay is desired, the ENABLE pin can be bypassed with a small capacitor up to a maximum of 1500pF.

#### TRIM/SS Pin

The TRIM/SS pin serves as another multi-purpose pin. First, it is used as the reference for the internal error amplifier. Connecting a resistor from TRIM/SS to SGND allows the reference to be margined down by as much as -20%. Connecting a resistor from TRIM/ SS to ENABLE will allow the reference and output voltage to be margined up by 10%. If the user wishes a longer start up time, a small ceramic capacitor can be added to TRIM/SS to increase it. It is critical to connect any device between TRIM/SS and SGND and not –IN, otherwise high frequency noise will be introduced to the reference and possibly cause erratic operation. Referring to the figures below, the appropriate trim up or trim-down resistor can be calculated using the equivalent circuit diagram and the equations. When trimming up, the trim-down resistor is not populated. When trimming down, the trim-up resistor is not populated. The soft-start time is adjustable and has a default value of 500µs to reach steady state. The internal soft-start capacitor value is 10nF.

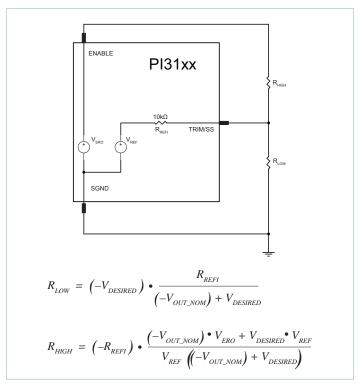


Figure 42 — Trim equations and equivalent circuit

$$C_{REF} = \frac{T_{SS\_DESIRED} - 230 \cdot 10^{-6}}{23000}$$

#### TM

The TM pin serves as an output indicator of the internal package temperature which is within ±5°K of the hottest junction temperature. Because of this, it is a good indicator of a thermal overload condition. The output is a scaled, buffered analog voltage which indicates the internal temperature in degrees Kelvin. Upon a thermal overload, the TM pin is pulled low, indicating a thermal fault has occurred. Upon restart of the converter, the TM pin reverts back to a buffered monitor. The thermal shutdown function of the PI31xx-00-HVMZ is a fault feature which interrupts power processing if a certain maximum temperature is exceeded. TM can be monitored by an external microcontroller or circuit configured as an adaptive fan speed controller so that air flow in the system can be conveniently regulated.

#### **SGND**

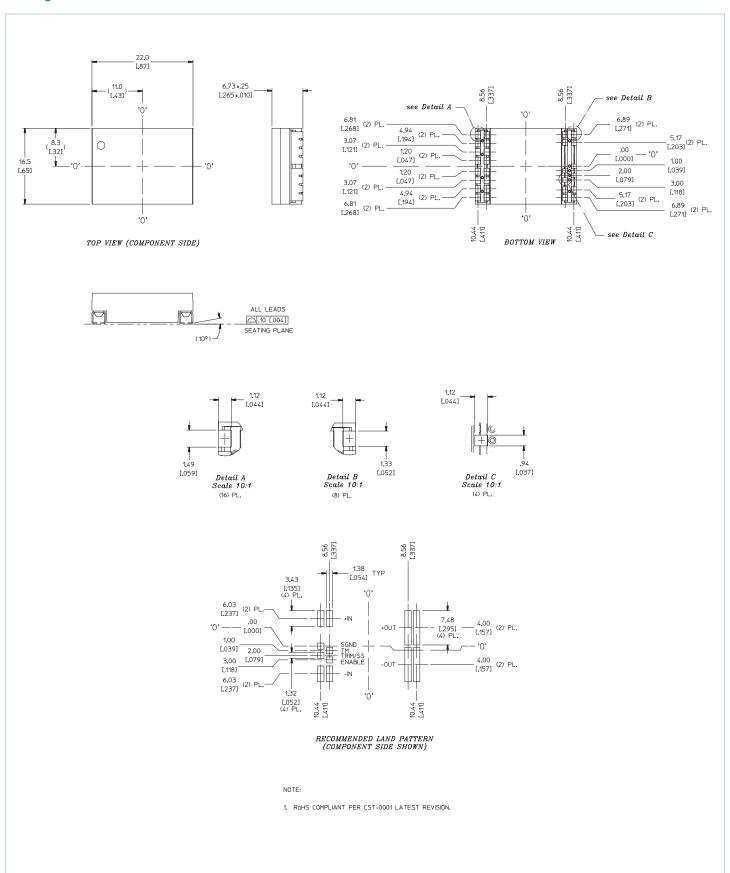
The PI31xx-00-HVMZ SGND pin is the "quiet" control circuitry return. It is basically an extension of the internal signal ground. To avoid contamination and potential ground loops, this ground should NOT be connected to –IN since it is already star connected inside the package. Connect signal logic to SGND.

#### Output Power Pins +OUT and -OUT

The output power terminals OUT(+) and OUT(-) deliver the maximum output current from the PI31xx-00-HVMZ through the J-lead output pins. This configuration allows for a low impedance output and should be connected to multi-layer PCB parallel planes for best performance. Due to the high switching frequency, output ripple and noise can be easily attenuated by adding just a few high-quality X7R ceramic capacitors while retaining adequate transient response for most applications. The PI31xx-00-HVMZ does not require any feedback loop compensation nor does it require any opto-isolation. All isolation is contained within the package. This greatly simplifies the use of the converter and eliminates all outside influences of noise on the quality of the output voltage regulation and feedback loop. It is important for the user to minimize resistive connections from the load to the converter output and to keep stray inductance to a minimum for best regulation and transient response. The very small size footprint and height of the PI31xx-00-HVMZ allows the converter to be placed in the optimum location to allow for tight connections to the point-of-load.



### **Package Outline & Recommended PCB Land Pattern**



**Figure 43** — Package outline & recommended PCB land pattern

# Not Recommended for New Designs PI31xx-00-HVMZ

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